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"Marked-Up" Copy of the Previous Claims

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3. (Amended) An epoxy resin composition for encapsulating of semiconductors according to claim 1, [or 2] wherein the epoxy resin and/or the phenolic resin have/has a naphthalene skeleton.

4. (Amended) A semiconductor device obtained by encapsulating with the epoxy resin composition according to claim 1[, 2 or 3].

5. (New) An epoxy resin composition for encapsulating of semiconductors according to claim 2 wherein the epoxy resin and/or the phenolic resin have/has a naphthalene skeleton.

6. (New) A semiconductor device obtained by encapsulating with the epoxy resin composition according to claim 2.

7. (New) A semiconductor device obtained by encapsulating with the epoxy resin composition according to claim 3.

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